

**/ Revised record**

| F | 2016-3     |   |                                                                                             |  |  |
|---|------------|---|---------------------------------------------------------------------------------------------|--|--|
| G | 2019-10-18 | 1 |                                                                                             |  |  |
| H | 2019-12-4  | 2 | C <sub>J1</sub> C <sub>J2</sub>                                                             |  |  |
| I | 2022-6-13  | 1 | ±17 V (            ), ±12 (            )<br>±17 kV (            ),<br>±12 kV (            ) |  |  |
|   |            |   |                                                                                             |  |  |
|   |            |   |                                                                                             |  |  |
|   |            |   |                                                                                             |  |  |
|   |            |   |                                                                                             |  |  |
|   |            |   |                                                                                             |  |  |
|   |            |   |                                                                                             |  |  |

## / Descriptions

SOT23-6 TVS  
Low Capacitance TVS Array in a SOT23-6 Plastic Package.

## / Features

4 ESD I/O 0.35pF

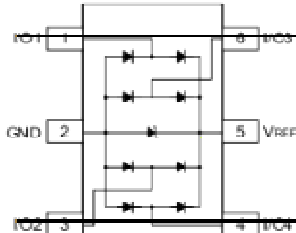
4 ESD protection structures, low capacitance for high-speed interfaces, Capacitance I / O channel is not more than 0.35pF, Low clamping voltage, Low operating voltage, suitable for high speed data transmission lines. HF Product.

## / Applications

ESD USB 2.0 IEC 61000-4-2(ESD)  $\pm 17\text{KV}$  ( $\pm 12\text{KV}$ )

ESD protection for high-speed data lines, such as USB 2.0, set-top boxes, monitors and so on.  
According to IEC 61000-4-2 (ESD) Standard:  $\pm 17\text{KV}$  (air discharge),  $\pm 12\text{KV}$  (contact discharge).

## / Equivalent Circuit



## / Pinning

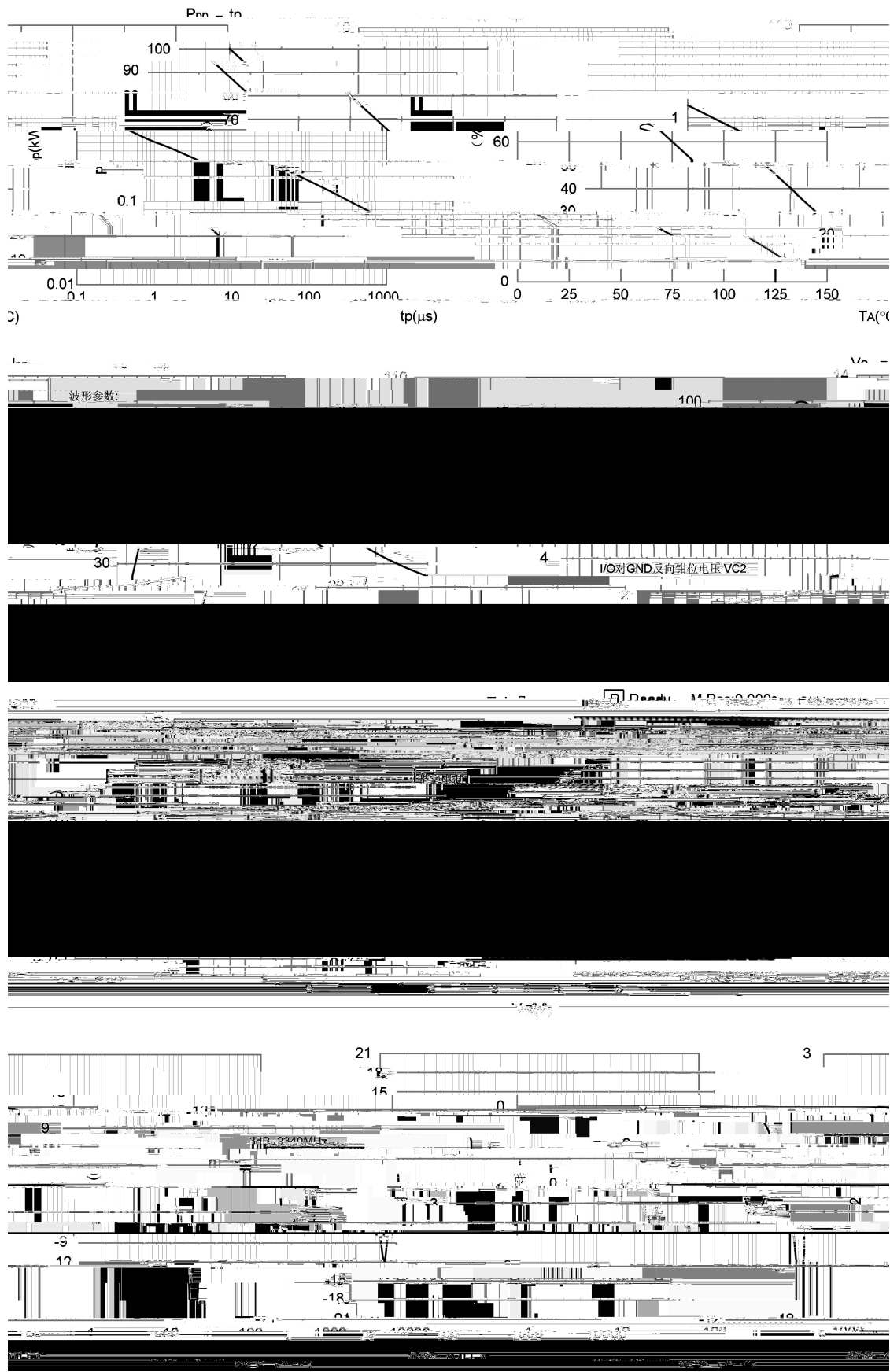


## / Marking

See Marking Instructions.

| Parameter                      | Symbol          | Rating | Unit |
|--------------------------------|-----------------|--------|------|
| Peak Pulse Power (tp = 8/20μs) | P <sub>PP</sub> | 150    | W    |

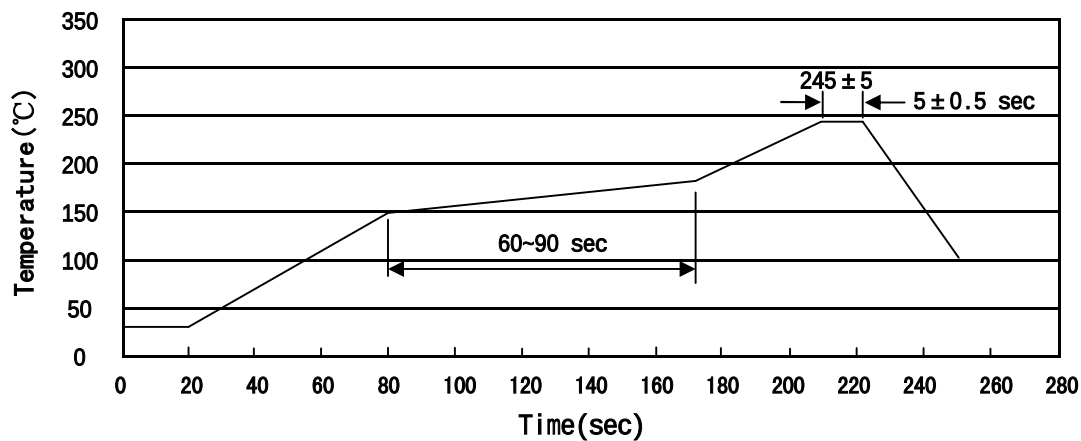
/ Electrical Characteristic Curve







( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- |   |       |     |    |           |                                          |
|---|-------|-----|----|-----------|------------------------------------------|
| 1 | 150   | 180 | 60 | 90sec;    | 1.Preheating:150~180°C, Time:60~90sec.   |
| 2 | 245±5 |     |    | 5±0.5sec; | 2.Peak Temp.:245±5°C, Duration:5±0.5sec. |
| 3 |       |     | 2  | 10°C/sec. | 3. Cooling Speed: 2~10°C/sec.            |

/ Resistance to Soldering Heat Test Conditions

260±5°C      10±1 sec.      Temp.:260±5°C      Time:10±1 sec

/ Packaging SPEC.

/ REEL

| Package Type<br>! | Units " # \$       |                         |                        |                             |                       | Dimension " % & (unit ' mm <sup>3</sup> ) |             |             |
|-------------------|--------------------|-------------------------|------------------------|-----------------------------|-----------------------|-------------------------------------------|-------------|-------------|
|                   | Units/Reel<br>只/卷盘 | Reels/Inner Box<br>卷盘/盒 | Units/Inner Box<br>只/盒 | Inner Boxes/Outer Box<br>盒/ | Units/Outer Box<br>只/ | Reel                                      | Inner Box ( | Outer Box ) |
| SOT23-5/6         | 3,000              | 10                      | 30,000                 | 4                           | 120,000               | 7" ×8                                     | 210×205×205 | 445×230×435 |

/ Notices